

FEATURES

Fast throughput rate of 1 MSPS Specified for V_{DD} of 2.09 V to 5.25 V **INL of ±1 LSB maximum** Analog input range of 0 V to V_{DD} **Ultralow power 367 µA typical at 3 V and 1 MSPS 324 nA typical at 3 V in power-down mode Reference provided by V_{DD} Flexible power/throughput rate management High speed serial interface: SPI®-/QSPI™-/MICROWIRE®-/ DSP-compatible Busy indicator Power-down mode 8-lead, 2 mm × 2 mm LFCSP package Temperature range: −40°C to +125°C**

APPLICATIONS

Battery-powered systems Handheld meters Medical instruments Mobile communications Instrumentation and control systems Data acquisition systems Optical sensors Diagnostic/monitoring functions Energy harvesting

GENERAL DESCRIPTION

The [AD7091](http://www.analog.com/AD7091) is a 12-bit successive approximation register analog-to-digital converter (SAR ADC) that offers ultralow power consumption (typically 367 µA at 3 V and 1 MSPS) while achieving fast throughput rates (1 MSPS with a 50 MHz SCLK). The [AD7091](http://www.analog.com/AD7091) operates from a single 2.09 V to 5.25 V power supply. Th[e AD7091](http://www.analog.com/AD7091) also features an on-chip conversion clock and a high speed serial interface.

The conversion process and data acquisition are controlled using a CONVST signal and an internal oscillator. Th[e AD7091](http://www.analog.com/AD7091) has a serial interface that allows data to be read after the conversion while achieving a 1 MSPS throughput rate. Th[e AD7091](http://www.analog.com/AD7091) uses advanced design and process techniques to achieve very low power dissipation at high throughput rates.

1 MSPS, Ultralow Power, 12-Bit ADC in 8-Lead LFCSP

Data Sheet **[AD7091](http://www.analog.com/AD7091)**

FUNCTIONAL BLOCK DIAGRAM

Figure 2. Power Dissipation vs. Throughput Rate

The reference is derived internally from V_{DD} . This design allows the widest dynamic input range to the ADC; that is, the analog input range for the [AD7091](http://www.analog.com/AD7091) is from 0 V to V_{DD} .

PRODUCT HIGHLIGHTS

- 1. Lowest Power 12-Bit SAR ADC Available.
- 2. High Throughput Rate with Ultralow Power Consumption.
- 3. Flexible Power/Throughput Rate Management. Average power scales with the throughput rate. Power-down mode allows the average power consumption to be reduced when the device is not performing a conversion.
- 4. Reference Derived from the Power Supply.
- 5. Single-Supply Operation.

Rev. 0 [Document Feedback](https://form.analog.com/Form_Pages/feedback/documentfeedback.aspx?doc=AD7091.pdf&product=AD7091&rev=0)

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REVISION HISTORY

10/12-Revision 0: Initial Version

SPECIFICATIONS

 $V_{DD} = 2.09$ V to 5.25 V, $f_{SAMPLE} = 1$ MSPS, $f_{SCLK} = 50$ MHz, $T_A = -40$ °C to +125°C, unless otherwise noted.

Table 1.

AD7091 Data Sheet

¹ Dynamic performance is achieved when SCLK operates in burst mode. Operating a free running SCLK during the acquisition phase degrades dynamic performance. ² See th[e Terminology](#page-8-0) section.

³ Sample tested during initial release to ensure compliance.

 4 SCLK is operating in burst mode and $\overline{\mathsf{CS}}$ is idling high. With a free running SCLK and $\overline{\mathsf{CS}}$ pulled low, the l $_{\text{DD}}$ static current is increased by 60 µA typical at V $_{\text{DD}}$ = 5.25 V.

TIMING SPECIFICATIONS

 V_{DD} = 2.09 V to 5.25 V, T_A = −40°C to +125°C, unless otherwise noted. Signals are specified from 10% to 90% of V_{DD} with a load capacitance of 12 pF on the output pin.¹

Table 2.

¹ Sample tested during initial release to ensure compliance.

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

Table 3.

¹ Transient currents of up to 100 mA do not cause silicon controlled rectifier (SCR) latch-up.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

Table 4. Thermal Resistance

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 5. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 7. SNR vs. Analog Input Frequency for Various Supply Voltages

Figure 8. THD vs. Analog Input Frequency for Various Supply Voltages

Figure 10. SINAD vs. Analog Input Frequency for Various Supply Voltages

Figure 11. Histogram of Codes at Code Center (V_{DD}/2)

Figure 14. Power-Down Supply Current vs. Temperature for Various Supply Voltages

TERMINOLOGY

Integral Nonlinearity (INL)

INL is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. For the [AD7091,](http://www.analog.com/AD7091) the endpoints of the transfer function are zero scale (a point 0.5 LSB below the first code transition) and full scale (a point 0.5 LSB above the last code transition).

Differential Nonlinearity (DNL)

DNL is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

Offset Error

Offset error is the deviation of the first code transition (00 … 000 to $00 \ldots 001$) from the ideal (such as $GND + 0.5$ LSB).

Gain Error

Gain error is the deviation of the last code transition (111 … 110 to 111 … 111) from the ideal (such as V_{DD} – 1.5 LSB) after the offset error has been adjusted out.

Track-and-Hold Acquisition Time

The track-and-hold amplifier returns to track mode after the end of a conversion. The track-and-hold acquisition time is the time required for the output of the track-and-hold amplifier to reach its final value, within ±0.5 LSB, after a conversion.

Signal-to-Noise Ratio (SNR)

SNR is the measured ratio of signal to noise at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ($f_{\text{SAMPLE}}/2$), excluding dc.

The ratio is dependent on the number of quantization levels in the digitization process: the more levels, the smaller the quantization noise. The theoretical signal-to-noise ratio for an ideal N-bit converter with a sine wave input is given by

*Signal-to-Noise Ratio = (*6.02*N +* 1.76*)* dB

Therefore, for a 12-bit converter, the SNR is 74 dB.

Signal-to-Noise-and-Distortion Ratio (SINAD)

SINAD is the measured ratio of signal to noise and distortion at the output of the ADC. The signal is the rms value of the sine wave, and noise is the rms sum of all nonfundamental signals up to half the sampling frequency $(f_{SAMPLE}/2)$, including harmonics, but excluding dc.

Total Unadjusted Error (TUE)

TUE is a comprehensive specification that includes the gain, linearity, and offset errors.

Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of harmonics to the fundamental. For the [AD7091,](http://www.analog.com/AD7091) THD is defined as

$$
THD (dB) = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2}}{V_1}
$$

where:

 $V₁$ is the rms amplitude of the fundamental.

 V_2 , V_3 , V_4 , V_5 , and V_6 are the rms amplitudes of the second through the sixth harmonics.

Spurious-Free Dynamic Range (SFDR)

SFDR, also known as peak harmonic or spurious noise, is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $f_{SAMPL}/2$ and excluding dc) to the rms value of the fundamental.

Aperture Delay

Aperture delay is the measured interval between the leading edge of the sampling clock and the point at which the ADC samples data.

Aperture Jitter

Aperture jitter is the sample-to-sample variation in the effective point in time at which the data is sampled.

Full Power Bandwidth

Full power bandwidth is the input frequency at which the amplitude of the reconstructed fundamental is reduced by 0.1 dB or 3 dB for a full-scale input.

THEORY OF OPERATION **CIRCUIT INFORMATION**

The [AD7091](http://www.analog.com/AD7091) is a 12-bit successive approximation register analog-to-digital converter (SAR ADC) that offers ultralow power consumption (typically 367 µA at 3 V and 1 MSPS) while achieving fast throughput rates (1 MSPS with a 50 MHz SCLK). The part operates from a single power supply in the range of 2.09 V to 5.25 V.

Th[e AD7091](http://www.analog.com/AD7091) provides an on-chip track-and-hold amplifier and an analog-to-digital converter (ADC) with a serial interface housed in a tiny 8-lead LFCSP package. This package offers considerable space-saving advantages compared with alternative solutions. The serial clock input accesses data from the part. The clock for the SAR ADC is generated internally.

The analog input range is 0 V to V_{DD} . An external reference is not required for the ADC, nor is there a reference on chip. The reference voltage for th[e AD7091](http://www.analog.com/AD7091) is derived from the power supply and, thus, provides the widest dynamic input range of 0 V to V_{DD} .

The [AD7091](http://www.analog.com/AD7091) also features a power-down option to save power between conversions. The power-down feature is implemented using the standard serial interface, as described in the [Modes of](#page-11-0) [Operation](#page-11-0) section.

CONVERTER OPERATION

The [AD7091](http://www.analog.com/AD7091) is a SAR ADC based around a charge redistribution DAC[. Figure 15](#page-9-4) an[d Figure 16](#page-9-5) show simplified schematics of the ADC.

[Figure 15](#page-9-4) shows the ADC during its acquisition phase; SW2 is closed and SW1 is in Position A. The comparator is held in a balanced condition, and the sampling capacitor acquires the signal on V_{IN} .

Figure 15. ADC Acquisition Phase

When the ADC starts a conversion, SW2 opens and SW1 moves to Position B, causing the comparator to become unbalanced (see [Figure 16\)](#page-9-5). The control logic and the charge redistribution DAC are used to add and subtract fixed amounts of charge from the sampling capacitor to bring the comparator back into a balanced condition. When the comparator is rebalanced, the conversion is complete. The control logic generates the ADC output code. [Figure 17](#page-9-6) shows the ADC transfer function.

ADC TRANSFER FUNCTION

The output coding of the [AD7091](http://www.analog.com/AD7091) is straight binary. The designed code transitions occur midway between successive integer LSB values, such as 0.5 LSB, 1.5 LSB, and so on. The LSB size for the [AD7091](http://www.analog.com/AD7091) is V_{DD} /4096. The ideal transfer characteristic for the [AD7091](http://www.analog.com/AD7091) is shown in [Figure 17.](#page-9-6)

TYPICAL CONNECTION DIAGRAM

[Figure 19](#page-10-2) shows a typical connection diagram for the [AD7091.](http://www.analog.com/AD7091) A positive power supply in the range of 2.09 V to 5.25 V should be connected to the V_{DD} pin. The reference is derived internally from V_{DD} and, for this reason, V_{DD} should be well decoupled to achieve the specified performance; typical values for the decoupling capacitors are 100 nF and 10 μ F. The analog input range is 0 V to V_{DD} . The typical value for the regulator bypass decoupling capacitor (REGCAP) is 1 µF. The conversion result is output in a 12-bit word with the MSB first.

Alternatively, because the supply current required by the [AD7091](http://www.analog.com/AD7091) is so low, a precision reference can be used as the supply source to the part. A reference from the [REF19x](http://www.analog.com/REF19) o[r ADR34xx](http://www.analog.com/ADR34) voltage reference family [\(REF195](http://www.analog.com/REF195) or [ADR3450](http://www.analog.com/ADR3450) for 5 V, an[d REF193](http://www.analog.com/REF193) or [ADR3430](http://www.analog.com/ADR3430) for 3 V) can be used to supply the required voltage to the ADC. This configuration is especially useful if the power supply is quite noisy, or if the system supply voltages are at some value other than 5 V or 3 V, such as 15 V.

If the busy indicator function is required, connect a pull-up resistor of typically 100 k Ω to V_{DD} to the SDO pin (see [Figure 19\)](#page-10-2).

In addition, for applications in which power consumption is a concern, the power-down mode can be used to improve the power performance of the ADC (see the [Modes of Operation](#page-11-0) section for more information).

ANALOG INPUT

[Figure 18](#page-10-3) shows an equivalent circuit of th[e AD7091](http://www.analog.com/AD7091) analog input structure. The D1 and D2 diodes provide ESD protection for the analog input. To prevent the diodes from becoming forward-biased and conducting current, ensure that the analog input signal never exceeds V_{DD} by more than 300 mV. These diodes can conduct a maximum of 10 mA without causing irreversible damage to the part.

Capacitor C1 in [Figure 18](#page-10-3) is typically about 1 pF and can primarily be attributed to pin capacitance. Resistor R1 is a lumped component made up of the on resistance of a switch. This resistor is typically about 500 Ω . Capacitor C2 is the ADC sampling capacitor and typically has a capacitance of 3.6 pF.

In applications where harmonic distortion and signal-to-noise ratio (SNR) are critical, the analog input should be driven from a low impedance source. Large source impedances significantly affect the ac performance of the ADC and may necessitate the use of an input buffer amplifier, as shown i[n Figure 19.](#page-10-2) The choice of the op amp is a function of the particular application.

When no amplifier is used to drive the analog input, the source impedance should be limited to low values. The maximum source impedance depends on the amount of total harmonic distortion (THD) that can be tolerated. The THD increases as the source impedance increases and performance degrades[. Figure 9](#page-6-1) shows a graph of THD vs. source impedance when using a supply voltage of 3 V and a sampling rate of 1 MSPS.

To achieve the specified performance, use an external filter—such as the one-pole, low-pass RC filter shown i[n Figure 19—](#page-10-2)on the analog input connected to the [AD7091.](http://www.analog.com/AD7091)

Figure 19. Typical Connection Diagram

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MODES OF OPERATION

The mode of operation of th[e AD7091](http://www.analog.com/AD7091) is selected by controlling the logic level of the CONVST signal when a conversion is complete. The two modes of operation are normal mode and power-down mode. These modes of operation provide flexible power management options, allowing optimization of the power dissipation to throughput rate ratio for different application requirements.

The logic level of the CONVST pin at the end of a conversion determines whether the [AD7091](http://www.analog.com/AD7091) remains in normal mode or enters power-down mode (see th[e Normal Mode](#page-11-1) section and the [Power-Down Mode](#page-11-2) section). Similarly, if the device is in powerdown mode, CONVST controls whether the device returns to normal mode or remains in power-down mode.

Normal Mode

The normal mode of operation is intended to achieve the fastest throughput rate performance. In normal mode, th[e AD7091](http://www.analog.com/AD7091) remains fully powered at all times, so power-up times are not a concern[. Figure 20](#page-11-3) shows the general timing diagram of the [AD7091](http://www.analog.com/AD7091) in normal mode.

In normal mode, the conversion is initiated on the falling edge of CONVST, as described in the [Serial Interface](#page-14-0) section. To ensure that the part remains fully powered at all times, CONVST must return high after t_7 and remain high until the conversion is complete. At the end of a conversion (denoted as EOC in [Figure 20\)](#page-11-3), the logic level of CONVST is tested.

To read back data stored in the conversion result register, wait until the conversion is complete, and then pull CS low. The conversion data is subsequently clocked out on the SDO pin (se[e Figure 20\)](#page-11-3). Because the output shift register is 12 bits wide, data is shifted out of the device as a 12-bit word under the control of the serial clock input (SCLK). After reading back the data, the user can pull CONVST low again to start another conversion after the t_{OUIET} time has elapsed.

Power-Down Mode

The power-down mode of operation is intended for use in applications where slower throughput rates and lower power consumption are required. In this mode, the ADC can be powered down after each conversion or after a series of conversions performed at a high throughput rate, with the ADC powered down for relatively long durations between these bursts of several conversions. When the [AD7091](http://www.analog.com/AD7091) is in power-down mode, the serial interface remains active even though all analog circuitry is powered down.

To enter power-down mode, pull CONVST low and keep it low prior to the end of a conversion (denoted as EOC i[n Figure 21\)](#page-11-4). After the conversion is complete, the logic level of the CONVST pin is tested. If the CONVST signal is logic low, the part enters power-down mode.

The serial interface of th[e AD7091](http://www.analog.com/AD7091) is functional in power-down mode; therefore, users can read back the conversion result after the part enters power-down mode.

To exit power-down mode and power up the [AD7091,](http://www.analog.com/AD7091) pull CONVST high at any time. On the rising edge of CONVST, the device begins to power up. The power-up time of the [AD7091](http://www.analog.com/AD7091) is 100 µs. To start the next conversion, operate the interface as described in the [Normal Mode](#page-11-1) section.

POWER CONSUMPTION

The two modes of operation for th[e AD7091—](http://www.analog.com/AD7091)normal mode and power-down mode (see the [Modes of Operation](#page-11-0) section for more information)—produce different power vs. throughput rate performances. Using a combination of normal mode and power-down mode achieves the optimum power performance.

To achieve optimum static current consumption, SCLK should be in burst mode and $\overline{\text{CS}}$ should idle high. Failure to adhere to these guidelines results in increased static current.

Improved power consumption for the [AD7091](http://www.analog.com/AD7091) can also be achieved by carefully selecting the V_{DD} supply (see [Figure 13\)](#page-7-0).

Power Consumption in Normal Mode

With a 3 V V_{DD} supply and a throughput rate of 1 MSPS, the I_{DD} current consumption for the part in normal operational mode is 367 μA (composed of 9.1 μA of static current and 357.9 μA of dynamic current during conversion). The dynamic current consumption is directly proportional to the throughput rate.

The following example calculates the power consumption of the [AD7091](http://www.analog.com/AD7091) when operating in normal mode with a 500 kSPS throughput rate and a 3 V supply.

The dynamic conversion time contributes 537 μW to the overall power dissipation as follows:

 $((500 \text{ kSPS}/1 \text{ MSPS}) \times 357.9 \text{ }\mu\text{A}) \times 3 \text{ V} = 537 \text{ }\mu\text{W}$

The contribution to the total power dissipated by the normal mode static operation is

9.1 μA \times 3 V = 27 μW

Therefore, the total power dissipated at 500 kSPS is

537 μW + 27 μW = 564 μW

Power Consumption Using a Combination of Normal Mode and Power-Down Mode

A combination of normal mode and power-down mode achieves the optimum power performance. This operation can be performed at constant sampling rates of <10 kSPS.

Figure 22 shows th[e AD7091](http://www.analog.com/AD7091) conversion sequence using a combination of normal mode and power-down mode with a throughput of 5 kSPS. With a V_{DD} supply voltage of 3 V, the static current is 9.1 μA. The dynamic current is 357.9 μA at 1 MSPS. The current consumption during power-down mode is 324 nA. A conversion takes typically 650 ns to complete, and the [AD7091](http://www.analog.com/AD7091) takes 100 μs to power up from power-down mode.

The dynamic conversion time contributes 5 μW to the overall power dissipation as follows:

 $((5 \text{ kSPS}/1 \text{ MSPS}) \times 357.9 \text{ }\mu\text{A}) \times 3 \text{ V} = 5 \text{ }\mu\text{W}$

The contribution to the total power dissipated by the normal mode static operation and the power-down mode is

 $(((100 \mu s + 650 \text{ ns})/200 \mu s) \times 9.1 \mu A) \times 3 \text{ V} +$ $((99.4 \text{ µs}/200 \text{ µs}) \times 324 \text{ nA}) \times 3 \text{ V} = 14 \text{ µW}$

Therefore, the total power dissipated at 5 kSPS is

$$
5 \mu W + 14 \mu W = 19 \mu W
$$

Figure 22. Conversion Sequence with Normal Mode and Power-Down Mode, 5 kSPS Throughput

Figure 23 and Figure 24 show the typical power dissipation vs. throughput rate for th[e AD7091](http://www.analog.com/AD7091) at 3 V for the $\rm V_{\scriptscriptstyle DD}$ supply. Figure 24 shows the reduction in power consumption that can be achieved when power-down mode is used compared with using only normal mode at lower throughput rates.

Figure 23. Power Dissipation vs. Throughput Rate (Full Range)

Figure 24. Power Dissipation vs. Throughput Rate (Lower Range)

SERIAL INTERFACE

The [AD7091](http://www.analog.com/AD7091) serial interface consists of four signals: SCLK, SDO, CONVST, and CS. The serial interface is used to access data from the result register and to control the modes of operation of the device.

- The SCLK pin is the serial clock input for the device.
- The SDO pin outputs the conversion result; data transfers take place with respect to SCLK.
- The CONVST pin is used to initiate the conversion process and to select the mode of operation of the [AD7091](http://www.analog.com/AD7091) (see the [Modes of Operation](#page-11-0) section).
- The CS pin is used to frame the data. The falling edge of CS takes the SDO line out of a high impedance state. A rising edge on \overline{CS} returns the SDO line to a high impedance state.

The logic level of \overline{CS} at the end of a conversion determines whether the busy indicator is enabled. This feature affects the propagation of the MSB with respect to \overline{CS} and SCLK.

BUSY INDICATOR ENABLED

When the busy indicator is enabled, the SDO pin can be used as an interrupt signal to indicate that a conversion is complete. The connection diagram for this configuration is shown i[n Figure 25.](#page-14-2) Note that a pull-up resistor to V_{DD} is required on the SDO pin.

Figure 25. Connection Diagram with Busy Indicator

The busy indicator allows the host to detect when the SDO pin exits the three-state condition after the end of a conversion. When the busy indicator is enabled, 13 SCLK cycles are required: 12 clock cycles to propagate the data and an additional clock cycle to return the SDO pin to the three-state condition.

To enable the busy indicator feature, a conversion must first be started. A high-to-low transition on CONVST initiates a conversion. This transition places the track-and-hold into hold mode and samples the analog input at this point. If the user does not want the [AD7091](http://www.analog.com/AD7091) to enter power-down mode, CONVST should be taken high before the end of the conversion.

A conversion requires 650 ns to complete. When the conversion process is finished, the track-and-hold returns to track mode. Before the end of a conversion, pull CS low to enable the busy indicator (se[e Figure 26\)](#page-14-3).

The conversion result is shifted out of the device as a 12-bit word under the control of SCLK and the logic level of CS at the end of a conversion. At the end of a conversion, SDO is driven low. SDO remains low until the MSB (DB11) of the conversion result is clocked out on the first falling edge of SCLK. DB10 to DB0 are shifted out on the subsequent falling edges of SCLK. The 13th SCLK falling edge returns SDO to a high impedance state. Data is propagated on SCLK falling edges and is valid on both the rising and falling edges of the next SCLK. The timing diagram for this operation is shown in [Figure 26.](#page-14-3)

If another conversion is required, pull CONVST low again and repeat the cycle.

Figure 26. Serial Port Timing with Busy Indicator

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BUSY INDICATOR DISABLED

To operate th[e AD7091](http://www.analog.com/AD7091) without the busy indicator, a conversion must first be started. A high-to-low transition on CONVST initiates a conversion. This transition places the track-and-hold into hold mode and samples the analog input at this point. If the user does not want th[e AD7091](http://www.analog.com/AD7091) to enter power-down mode, CONVST should be taken high before the end of the conversion.

A conversion requires 650 ns to complete. When the conversion process is finished, the track-and-hold returns to track mode. To prevent the busy indicator from becoming enabled, ensure that \overline{CS} is pulled high before the end of the conversion (se[e Figure 27\)](#page-15-1). The conversion result is shifted out of the device as a 12-bit word under the control of SCLK and CS. The MSB (Bit DB11) is clocked out on the falling edge of \overline{CS} . DB10 to DB0 are shifted out on the subsequent falling edges of SCLK. The 12th SCLK falling edge returns SDO to a high impedance state. After all the data is clocked out, pull \overline{CS} high again. Data is propagated on SCLK falling edges and is valid on both the rising and falling edges of the next SCLK. The timing diagram for this operation is shown in [Figure 27.](#page-15-1)

If another conversion is required, pull CONVST low again and repeat the cycle.

SOFTWARE RESET

The [AD7091](http://www.analog.com/AD7091) requires the user to initiate a software reset upon power-up. Note that failure to apply the correct software reset command may result in a device malfunction. The timing diagram for the software reset operation is shown i[n Figure 28.](#page-16-2)

To issue a software reset,

- 1. Start a conversion by pulling CONVST low.
- 2. Read back the conversion result by pulling \overline{CS} low after the conversion is complete.
- 3. Between the second and eighth SCLK cycles, pull $\overline{\text{CS}}$ high to short cycle the read operation.
- 4. At the end of the next conversion, the software reset is executed.

As soon as a software reset is issued, the user can start another conversion by pulling CONVST low.

INTERFACING WITH AN 8-/16-BIT SPI BUS

It is also possible to interface the [AD7091](http://www.analog.com/AD7091) with a conventional 8-/16-bit SPI bus.

Performing conversions and reading results can be achieved by configuring the host SPI interface for 16 bits, which results in providing an additional four SCLK cycles to complete a conversion compared with the standard interface methods (see the Busy [Indicator](#page-14-1) Enabled section and the Busy [Indicator](#page-15-0) Disabled section).

After the 13th SCLK falling edge with the busy indicator enabled or after the $12th$ SCLK falling edge with the busy indicator disabled, SDO returns to a high impedance state. The additional four bits should be treated as don't care bits by the host. All other timings are as shown in [Figure 26](#page-14-3) an[d Figure 27,](#page-15-1) with t_{OUTET} starting after the 16th SCLK cycle.

A software reset can be performed by configuring the SPI bus for eight bits and performing the operation described in th[e Software](#page-16-0) [Reset](#page-16-0) section.

Figure 28. Software Reset Timing

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OUTLINE DIMENSIONS

2.00 mm × 2.00 mm Body, Ultra Thin, Dual Lead (CP-8-10) Dimensions shown in millimeters

ORDERING GUIDE

 $1 Z =$ RoHS Compliant Part.

NOTES

NOTES

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